SiHB15N65E

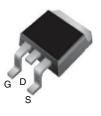


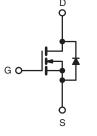


E Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.28					
Q _g max. (nC)	96					
Q _{gs} (nC)	11					
Q _{gd} (nC)	21					
Configuration	Sing	le				

D²PAK (TO-263)





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB15N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unle	ess otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	650	v		
Gate-Source Voltage	V _{GS}	± 30	v		
Continuous Drain Current (T 150 °C)	V _{GS} at 10 V	$10 \text{ V} \frac{\text{T}_{\text{C}} = 25 \text{ °C}}{\text{T}_{\text{C}} = 100 \text{ °C}} \text{I}_{\text{D}}$	1	15	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	Ι _D	10	А
Pulsed Drain Current ^a	I _{DM}	38			
Linear Derating Factor		1.4	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	286	mJ	
Maximum Power Dissipation	PD	34	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	25 °C	-15.77-11	37	V/ns	
Reverse Diode dV/dt ^d	dV/dt	23	v/ns		
Soldering Recommendations (Peak Temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.5 A.

1.6 mm from case. c.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7				

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Document Number: 91536



COMPLIANT HALOGEN FREE



SiHB15N65E

Vishay Siliconix

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = 250 μ A		650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		-	4	V
	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μA
		V _{DS} =	= 650 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	Tate Voltage Drain Current I_{DSS} $V_{DS} = 520 V, V_{GS} = 0 V, T_J = 125 °C$		/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8 A	-	0.23	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS}	_s = 30 V, I _D = 8 A	-	5.6	-	S
Dynamic				1	I	1	
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1640	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	80	-	-
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		63	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{DS} = 0.0$			213	-	
Total Gate Charge	Qg				48	96	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 8 \text{ A}, V_{DS} = 520 \text{ V}$	-	11	-	nC
Gate-Drain Charge	Q _{gd}			-	21	-	
Turn-On Delay Time	t _{d(on)}			-	18	36	- ns
Rise Time	t _r	V _{DD}	= 520 V, I _D = 8 A,	-	24	48	
Turn-Off Delay Time	t _{d(off)}		= 10 V, $R_g = 9.1 \Omega$	-	48	96	
Fall Time	t _f			-	25	50	
Gate Input Resistance	Rg	f = 1	MHz, open drain	-	0.8	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	IS	MOSFET sym showing the	MOSFET symbol showing the		-	15	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction		-	-	38	A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 8 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	325	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	25 °C, I _F = I _S = 8 A, 100 A/μs, V _B = 400 V	-	4.6	-	μC
	-211	dl/dt = 1		20	_	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

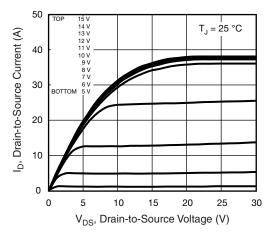


Fig. 1 - Typical Output Characteristics

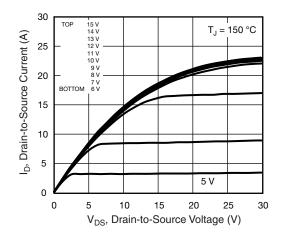


Fig. 2 - Typical Output Characteristics

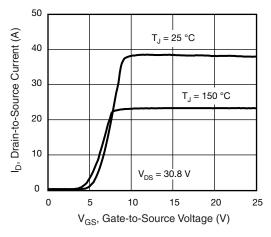


Fig. 3 - Typical Transfer Characteristics

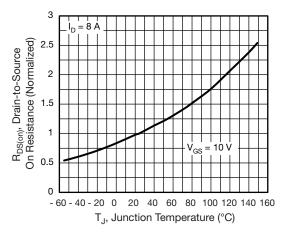


Fig. 4 - Normalized On-Resistance vs. Temperature

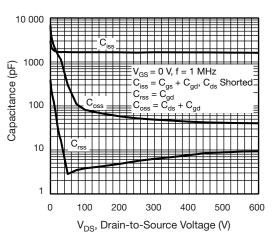


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

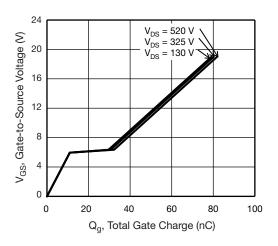


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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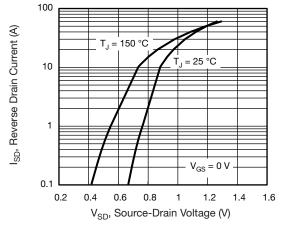
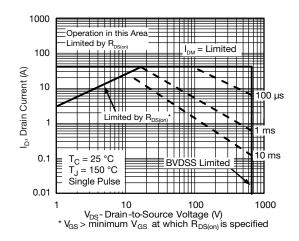


Fig. 7 - Typical Source-Drain Diode Forward Voltage





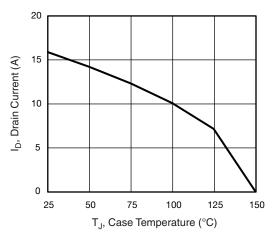


Fig. 9 - Maximum Drain Current vs. Case Temperature

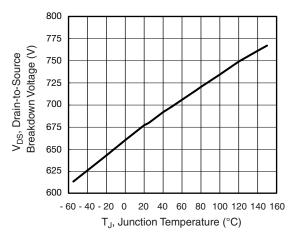
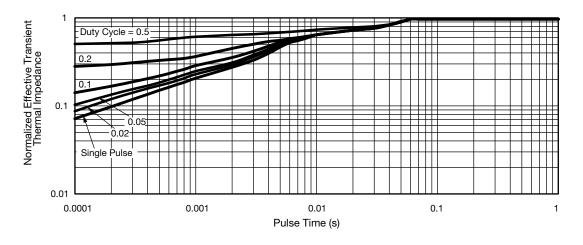


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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 V_{DS} V_{DS} V_{D

Fig. 12 - Switching Time Test Circuit

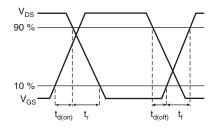


Fig. 13 - Switching Time Waveforms

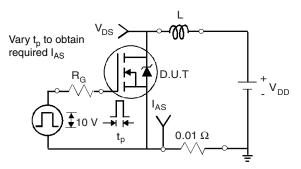


Fig. 14 - Unclamped Inductive Test Circuit

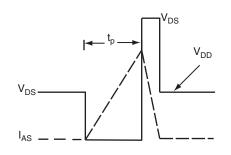


Fig. 15 - Unclamped Inductive Waveforms

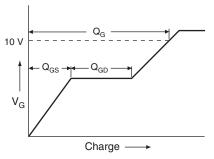


Fig. 16 - Basic Gate Charge Waveform

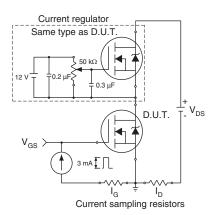
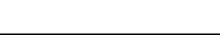


Fig. 17 - Gate Charge Test Circuit

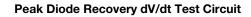
5

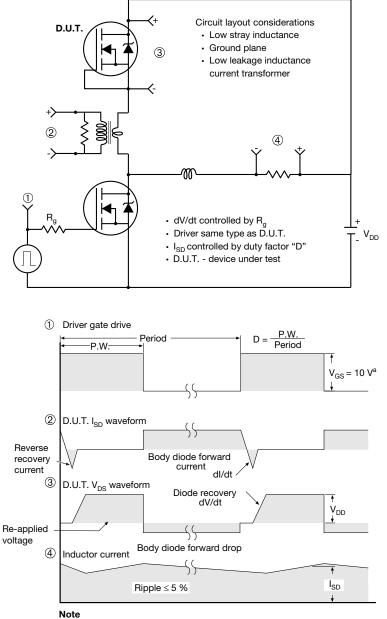
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a. $V_{GS} = 5$ V for logic level devices

Fig. 18 - For N-Channel

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SHAY

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INCHES				MILLIN	METERS INCHES		HES
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

А

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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